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| 10/560,160 | 01/29/2007 | Kenji Kohiro | 3885-0109PUS1 | 9498 | |
| 2592 7590 01/20/2010 BIRCH STEWART KOLASCH & BIRCH PO BOX 747 | | | EXAMINER | | |
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail $\,$ address(es):

mailroom@bskb.com

Application No. Applicant(s) 10/560,160 KOHIRO ET AL. Office Action Summary Examiner Art Unit Ori Nadav 2811 -- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS. WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). Status 1) Responsive to communication(s) filed on 10 November 2009. 2a) ☐ This action is FINAL. 2b) This action is non-final. 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. Disposition of Claims 4) Claim(s) 1-18 is/are pending in the application. 4a) Of the above claim(s) 1-7 is/are withdrawn from consideration. 5) Claim(s) _____ is/are allowed. 6) Claim(s) 8-18 is/are rejected. 7) Claim(s) _____ is/are objected to. 8) Claim(s) _____ are subject to restriction and/or election requirement. Application Papers 9) The specification is objected to by the Examiner. 10) ☐ The drawing(s) filed on 12 December 2005 is/are: a) ☐ accepted or b) ☐ objected to by the Examiner. Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152. Priority under 35 U.S.C. § 119 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.

1) Notice of References Cited (PTO-892)

Paper No(s)/Mail Date 12/12/05.

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) Information Disclosure Statement(s) (PTO/SD/08)

Attachment(s)

Interview Summary (PTO-413)
 Paper No(s)/Mail Date.

6) Other:

5) Notice of Informal Patent Application

DETAILED ACTION

Election/Restrictions

Applicant's election with traverse of the embodiment of figure 3 in the reply filed on 08/14/2009 is acknowledged. The traversal is on the ground(s) that "the invention claimed in method claims 8-18, and the invention claimed in product claim 1 are all clearly related". Applicant further argues that "the election requirement set forth by the USPTO is incompatible with the acceptance of the unity of the invention standard in the international phase. In particular, it is submitted that at least instant claims 1, 8-9 and 18 are so linked as to form a single general inventive concept".

This is not found persuasive because although the invention claimed in method claims 8-18, and the invention claimed in product claim 1 are all related, the claims lack the same special technical features. Furthermore, it is unclear to the examiner why the election requirement set forth by the USPTO is incompatible with the acceptance of the unity of the invention standard in the international phase. All the claims are not linked as to form a single general inventive concept.

The requirement is still deemed proper and is therefore made FINAL.

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

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Claims 1-18 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

The claimed limitation of "which method of producing a compound semiconductor is characterized in that", as recited in claim 8, is unclear as to whether said compound semiconductor is the same element recited earlier, or a different element.

The claimed limitation of "an InGaP buffer layer or InGaAsP buffer layer is grown on a GaAs substrate; and an InP crystal or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs is grown on the InGaP buffer layer or InGaAsP buffer layer", as recited in claim 8, is unclear as to whether said elements are the same elements recited earlier, or a different elements.

The claimed limitation of "a compound semiconductor" and "InGaAsP buffer layer", as recited in dependent claims 9-11 and 14, is unclear as to whether said elements are the same elements recited earlier, or a different elements.

The claimed limitation of "the crystal", as recited in claim 18, is unclear as to which crystal applicant refers.

The claimed limitation of "having a thickness", as recited in claim 18, is unclear as to which element has said thickness.

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Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filled in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filled in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 8 and 17-18, as best understood, are rejected under 35 U.S.C. 102(e) as being anticipated by Kudo et al. (2003/0062538).

Regarding claim 8, Kudo et al. teach in figure 4 and related text a method of producing a compound semiconductor by growing on a GaAs substrate 1 InP crystal 9 or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, which method of producing a compound semiconductor is characterized in that:

an InGaP buffer layer 4 or InGaAsP buffer layer is grown on a GaAs substrate 1; and

an InP crystal 9 or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs is grown on the InGaP buffer layer or InGaAsP buffer layer.

Regarding claim 18, Kudo et al. teach in figure 4 and related text a method of producing a compound semiconductor, which comprises forming on a GaAs substrate 1 a layer of

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InP crystal 9 or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, wherein the crystal is formed on the GaAs substrate via an InGaP buffer layer 4 or an InGaAsP buffer layer having a thickness of not less than 5 nm and not greater than 500 nm.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 9-16, as best understood, are rejected under 35 U.S.C. 103(a) as being unpatentable over Kudo et al. in view of Ohkubo et al. (5,492,860).

Regarding claims 9, 13 and 16, Kudo et al. teach substantially the entire claimed structure, as recited in claim 8, including growth of the InGaP buffer layer or InGaAsP buffer layer is conducted to a thickness of not less than 5 nm and not greater than 500 nm.

Kudo et al. do not disclose the temperature at which the layers grow.

Ohkubo et al. teach growing an InGaP layer and an InP layer at 400 °C temperature. It would have been obvious to a person of ordinary skill in the art at the time the

invention was made to conduct the growth of the InGaP buffer layer or InGaAsP buffer layer at a temperature of not lower than 400 °C and not higher than 600 °C and growth

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of the InP crystal or a compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs is conducted at a temperature of not lower than 400 °C and not higher than 700 °C, in Kudo et al.'s device in order to provide better quality crystal.

Regarding claim 10, Kudo et al. teach an InP buffer layer 5 is grown on the InGaP buffer layer or InGaAsP buffer layer.

Kudo et al. do not disclose the temperature at which the layer grows.

Ohkubo et al. teach the growing temperature of an InP layer.

It would have been obvious to a person of ordinary skill in the art at the time the invention was made to form Kudo et al.'s device by forming the InP buffer layer in temperature to a prescribed annealing temperature and annealed, and the temperature is lowered to a prescribed crystal growth temperature for growing the InP crystal or compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, whereafter the InP crystal or compound semiconductor crystal is grown, in order to improve the crystal quality of the layers.

Regarding claim 11, Kudo et al. and Ohkubo et al. teach substantially the entire claimed structure, as applied to claims 8 and 9 above, except forming the InGaP buffer layer to a thickness of not less than 5 nm and not greater than 300 nm.

It would have been obvious to a person of ordinary skill in the art at the time the invention was made to form the InGaP buffer layer to a thickness of not less than 5 nm

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and not greater than 300 nm, in prior art's device in order to reduce the size of the device.

Regarding claim 12, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form the InP buffer layer to a thickness of not less than 20 nm and not greater than 200 nm, in prior art's device in order to reduce the size of the device.

Regarding claim 14, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form prior art's device by forming the InP buffer layer in temperature to a prescribed annealing temperature and annealed, and then, before growing the InP crystal or compound semiconductor crystal whose lattice constant is closer to that of InP than that of GaAs, an operation tbr lowering the temperature from the prescribed annealing temperature to a prescribed crystal growth temperature and again raising it to the prescribed annealing temperature is repeated not less than one time and not more than five times, whereafter the temperature is lowered to the prescribed crystal growth temperature, in order to improve the crystal quality of the layers.

Regarding claim 15, it would have been obvious to a person of ordinary skill in the art at the time the invention was made to form prior art's device by using the prescribed

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annealing temperature not lower than 650 °C and not higher than 730 °C in order to

have better control over the growth of the layers.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Ori Nadav whose telephone number is 571-272-1660.

The examiner can normally be reached between the hours of 7 AM to 4 PM (Eastern

Standard Time) Monday through Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Lynne Gurley can be reached on 571-272-1670. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent

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